

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 7,260,230 B2
APPLICATION NO. : 10/801371
DATED : August 21, 2007
INVENTOR(S) : Feng J. Nan

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

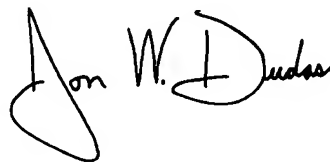
On the Title Page:

At item (73), "LLC." should be -- LLC --.

At Column 8, lines 21-22, "the backplate conductive backplate assembly comprising a is" should be -- the backplate assembly comprising a conductive backplate is --.

Signed and Sealed this

Fourth Day of March, 2008

A handwritten signature in black ink, appearing to read "Jon W. Dudas". The signature is stylized with a large, looped initial "J" and a cursive "Dudas".

JON W. DUDAS
Director of the United States Patent and Trademark Office